Conductive polymer chip capacitors (Bottom surface electrode type: Large capacitance)

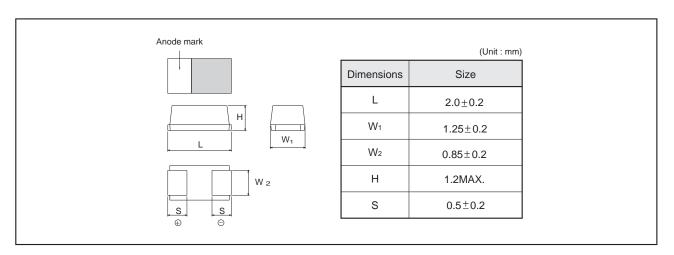
TCTO Series P Case

Data sheet

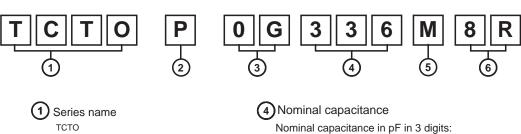
Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) Bottom electrode configuration results in the largest capacitance.
- 3) Compact, low profile, ultra-high capacitance contribute to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

Dimensions



●Part No. Explanation



(2) Case style

P: 2012-12 (0805) size

(3) Rated voltage

Rated voltage (V) 2.5 4 6.3 10 0E 0G 0J 1A CODE

2 significant figures followed by the figure representing the number of 0's.

(5) Capacitance tolerance

M: ±20%

(6)Taping

8 : Tape width

R: Positive electrode on the side opposite to sprocket hole

^{*}This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

TCTO Series P Case Data sheet

●Rated table

(ESR : $m\Omega$)

				(LSIX . 11152)					
Capacitance	Rated voltage (V.DC)								
(μF)	2.5	4	6.3	10					
10 (106)				300					
22 (226)				☆300					
47 (476)		☆300	☆300						
100 (107)	☆300								

☆ Under development

Marking

The indications listed below should be given on the surface of a capacitor.

: The polarity should be shown by $\hfill\Box$ bar. (on the anode side)

(1) Polarity : The polarity should be shown by \square bar. (2) Rated DC voltage : A voltage code is shown as below table.

(3) Capacitance : A capacitance code is shown as below table.

Voltage Code	Rated DC Voltage (V)					
е	2.5					
g	4					
j	6.3					
Α	10					
	е					

Capacitance Code	Nominal Capacitance (μF)				
а	10				
j	22				
S	47				
ā	100				

Visual typical example

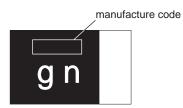
Voltage code and capacitance code are variable with parts number.

[Pcase]

EX.)

 $\frac{g}{(1)} \frac{n}{(2)}$

(1) voltage code (2) capacitance code



● Characteristics

Iter		Performance					Test	Test conditions (based on JIS C 5101–1 and JIS C 5101–3				
Departing Temperature -55°C to +105°C					+105	°C	Voltage reduction when temperature exceeds +85°C					
Maximum operat temperature with derating	ing no voltage	+8	35°	°C								
Rated voltage (VDC)	2.5 4 6.3 10						at 85°C				
Category voltag	Category voltage (VDC) 2 3.2 5 8						at 10	at 105°C				
Surge voltage (VDC)	3.2 5.0 8 13						at 85°C				
DC Leakage current Shall be satisfied the voltage on "Standard list"						As p	As per 4.9 JIS C 5101-1 As per 4.5.1 JIS C 5101-3 Voltage : Rated voltage for 5min					
Capacitance tolerance Shall be satisfied allowance range. ±20%				As p Mea Mea	As per 4.7 JIS C 5101-1 As per 4.5.2 JIS C 5101-3 Measuring frequency: 120±12Hz Measuring voltage : 0.5Vrms +1.5 to 2V.DC Measuring circuit : DC Equivalent series circuit							
Tangent of loss angle (Df, $\tan \delta$) Shall be satisfied the voltage on " Standard list "						As p Mea Mea	As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency : 120±12Hz Measuring voltage : 0.5Vrms +1.5 to 2V.DC Measuring circuit : DC Equivalent series circuit					
			Shall be satisfied the voltage on " Standard list "				As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency: 100±10kHz Measuring voltage: 0.5Vrms or less Measuring circuit: DC Equivalent series circuit					
Resistance to Soldering heat Appearance			There should be no significant abnormality. The indications should be clear.						As per 4.14 JIS C 5101-1 As per 4.6 JIS C 5101-3			
	L.C.	Le	ess	than	300	% of initial limit		Dip in the solder bath Solder temp: 240±5°C				
	ΔC / C	Within ±20% of initial value						Duration : 10±0.5s				
Df (tan δ)			ess	s than	300	% of initial limit	Repetition : 1 After the specimens, leave it at room temperature for over 24h and then measure the sample.					
Temperature cycle	Appearance	There should be no significant abnormality. The indications should be clear.					As p	As per 4.16 JIS C 5101-1 As per 4.10 JIS C 5101-3				
	L.C.	Le	ess	than	100	0% of initial limit		Repetition: 5 cycles (1 cycle: steps 1 to 4) without discontinuation.				
ΔC / C		Within ±20% of initial value						0.0 .	Temp. Time			
	Df (tan δ)	l e	22.5	than	300	% of initial limit		1	-55±3°C 30±3min.			
	. (0)	2000 than 00070 of initial lifting						2	Room temp. 3min. or less			
									105±2°C 30±3min.			
								4	Room temp. 3min. or less			
Moisture resistance	Appearance					pe no significant abnormality.		As per 4.22 JIS C 5101-1 As per 4.12 JIS C 5101-3				
	L.C.	Le	ess	than	300	% of initial limit		After leaving the sample under such atmospheric condition that the temperature and humidity are				
	ΔC / C	W	ith	in +3	0/-20)% of initial value		40±2°C and 90 to 95% RH, respectively, for 500±12h				
	Df (tan δ)	Less than 300% of initial limit						leave it at room temperature for 24h and then measure the sample.				

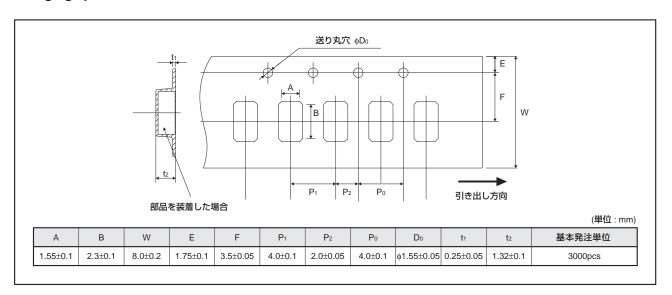
Iten	า	Performance	Test conditions (based on JIS C 5101–1 and JIS C 5101–3)					
Temperature Temp.		–55°C	As per 4.29 JIS C 5101-1 As per 4.13 JIS C 5101-3					
Stability	ΔC / C	Within 0/–20% of initial value	As per 4.13 313 C 3101-3					
	Df (tan δ)	Shall be satisfied the voltage on " Standard list "						
	L.C.	-						
	Temp.	+105°C						
	ΔC / C	Within +50/0% of initial value						
Df (tan δ)		Shall be satisfied the voltage on " Standard list "						
	L.C.	Less than 1,000% of initial value						
Surge voltage	Appearance	There should be no significant abnormality.	As per 4.26JIS C 5101-1 As per 4.14JIS C 5101-3					
	L.C.	Less than 200% of initial value	Apply the specified surge voltage every 5 ± 0.5 min. for 30 ± 5 s. each time in the atmospheric condition of $85\pm2^{\circ}$ C Repeat this procedure 1,000 times.					
	ΔC/C	Within ±20% of initial value						
	Df (tan δ)	Less than 200% of initial limit	After the specimens, leave it at room temperature for over 24h and then measure the sample.					
Loading at	Appearance	There should be no significant abnormality.	As per 4.23 JIS C 5101-1					
High temperature	L.C.	Less than 400% of initial limit	As per 4.15 JIS C 5101-3					
			After applying the rated voltage for $1000+36/0$ h without discontinuation via the serial resistance of 3Ω or less at a temperature of $85\pm2^{\circ}$ C, leave the sample at room					
	ΔC / C	Within ±20% of initial value						
	Df (tan δ)	Less than 300% of initial limit	temperature / humidity for 24h and measure the value.					
Terminal strength	Capacitance	The measured value should be stable.	As per 4.35 JIS C 5101-1 As per 4.9 JIS C 5101-3					
oog	Appearance	There should be no significant abnormality.	A force is applied to the terminal until it bends to 1mm and					
			by a prescribed tool maintain the condition for 5s. (See the figure below)					
			(Unit : mm)					
			F (Apply force)					
			R230 / 1					
			1					
			thickness=1.6mm					
			[!] 45 [!] 45 [!]					
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3					
			Apply force of 5N in the two directions shown in the figure					
			below for 10±1s after mounting the terminal on a circuit board.					
			product					
			Apply force					
			Apply force					
			Apply force a circuit board					
Dimensions		Refer to "External dimensions"						
Dimensions		Refer to "External dimensions"	a circuit board					
	olvents		a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade.					
Dimensions Resistance to so	olvents	Refer to "External dimensions" The indication should be clear	Measure using a caliper of JIS B 7507 Class 2 or higher grade. As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3					
	olvents		Measure using a caliper of JIS B 7507 Class 2 or higher grade. As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room					
Resistance to so	plvents	The indication should be clear	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.					
	olvents	The indication should be clear 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3					
Resistance to so	olvents	The indication should be clear 3/4 or more surface area of the solder coated	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s					
Resistance to so	plvents	The indication should be clear 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h.					
Resistance to so	plvents	The indication should be clear 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C					
Resistance to so	plvents	The indication should be clear 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration : 3±0.5s Solder : M705					
Resistance to so	olvents	The indication should be clear 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp. : 245±5°C Duration : 3±0.5s					
Resistance to so	Divents	The indication should be clear 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder. Measure value should not fluctuate during	Measure using a caliper of JIS B 7507 Class 2 or higher grade. As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.7 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75% As per 4.17 JIS C 5101-1					
Resistance to so		The indication should be clear 3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	Measure using a caliper of JIS B 7507 Class 2 or higher grade. As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature. As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1 h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75%					

Standard products list

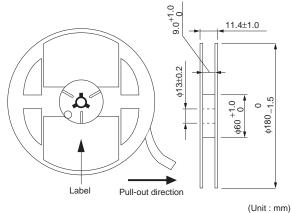
Part No.	Rated voltage 85°C	Category voltage 105°C	Surge voltage 85°C	Cap. 120Hz	Tolerance	Leakage current 25°C	current		:	ESR 100kHz
	(V)	(V)	(V)	(μF)	(%)	1WV.5min (μA)	–55°C	25°C	105°C	(mΩ)
* TCTO P 0E 107 M8R	2.5	2	3.2	100	± 20	25.0	15	15	20	300
* TCTO P 0G 476 M8R	4	3.2	5	47	± 20	18.8	15	15	20	300
* TCTO P 0J 336 M8R	6.3	5	8	33	± 20	20.8	15	15	20	300
* TCTO P 1J 476 M8R	6.3	5	8	47	± 20	29.6	15	15	20	300
TCTO P 1A 106 M8R	10	8	13	10	± 20	10.0	15	15	20	300
* TCTO P 1A 226 M8R	10	8	13	22	± 20	22.0	15	15	20	300

^{* =} Under development

Packaging specifications



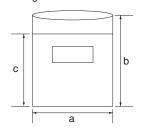
Reel dimensions



EIAJ ET-7200A

Damp proof package

- 1) One reel is packed in aluminum bag. The size of aluminum bag is 240(a) x 250(b)mm. The size up to 230(c)mm is to zipper.
- ② A desiccant is packed with a reel.
- ③ The aluminum bag is heat-sealed.④ The label of the same as the label on the reel is placed on the aluminum bag.



Notice

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CL ACCIII	
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII	

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

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Notice-PGA-E Rev.001

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ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
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- Тестирование поставляемой продукции.
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Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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